

FIG. 1

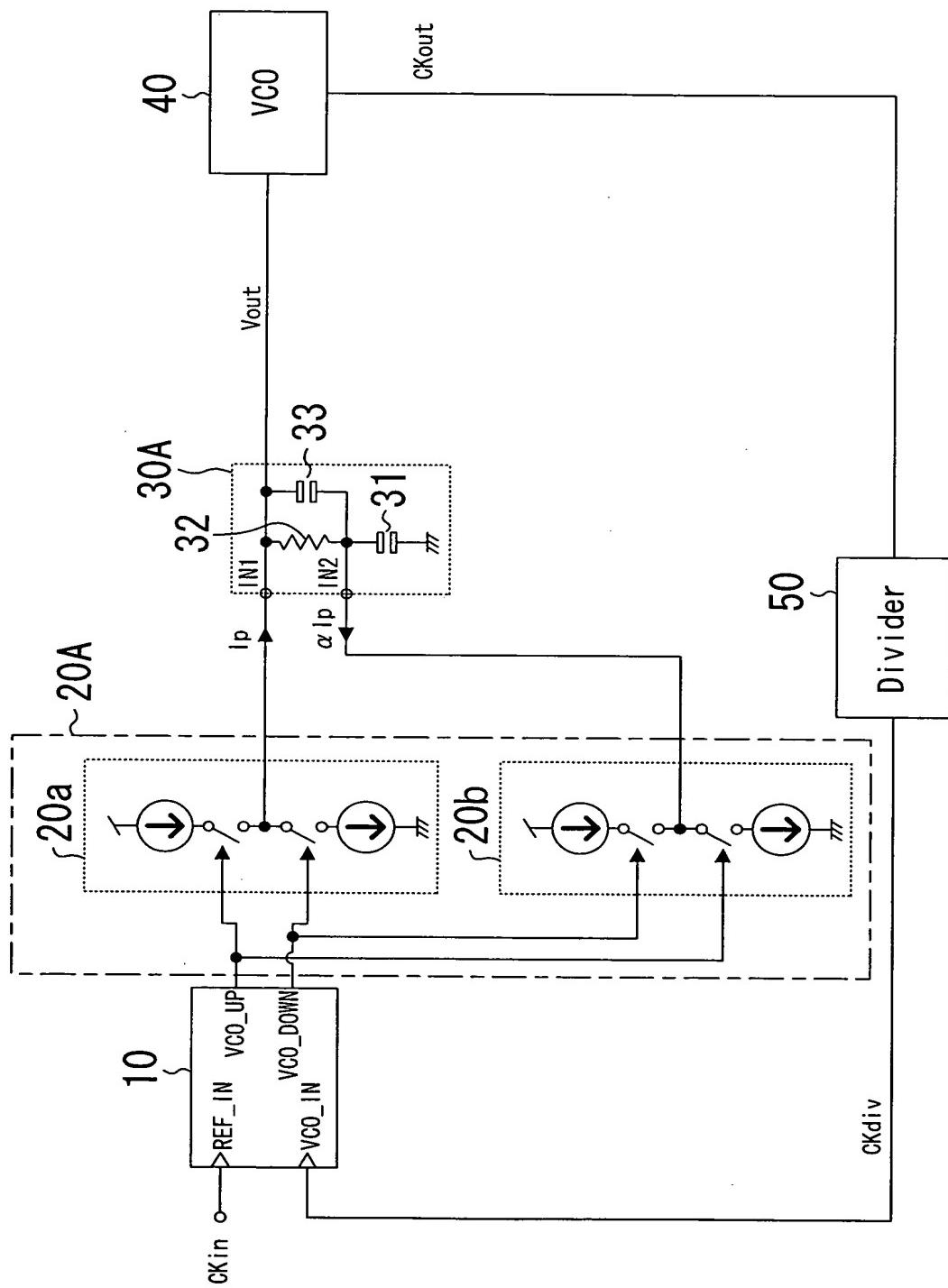
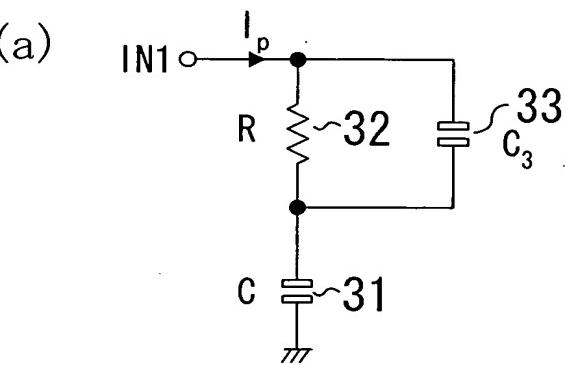
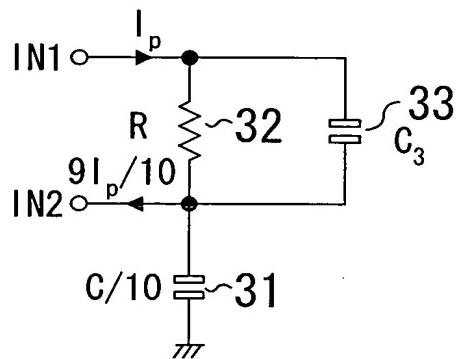


FIG. 2

(a) 30

$\uparrow \downarrow$ Equivalent conversion

(b) 30A

$\uparrow \downarrow$ Equivalent conversion

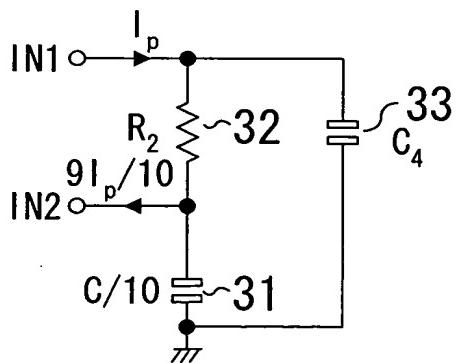
(c) 30B

FIG. 3

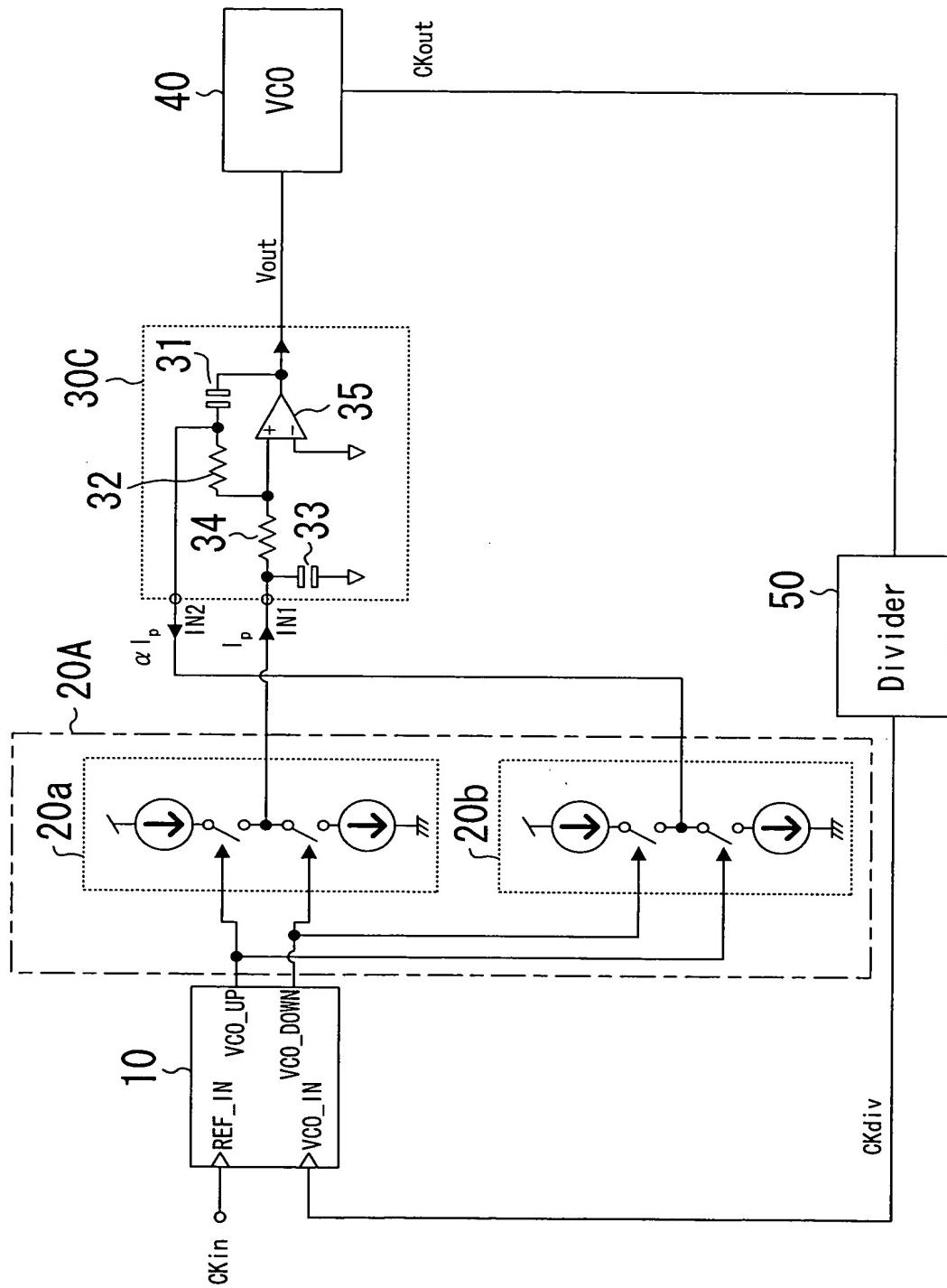
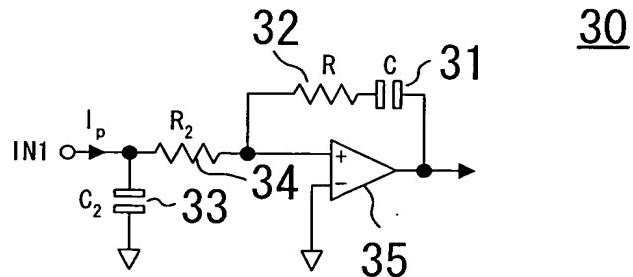


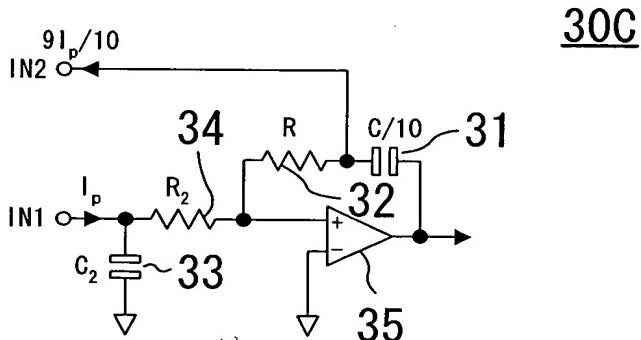
FIG. 4

(a)



↔ Equivalent conversion

(b)



↔ Equivalent conversion

(c)

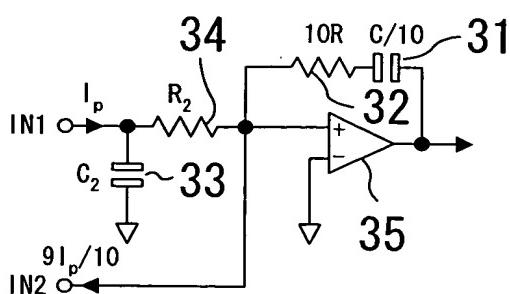


FIG. 5

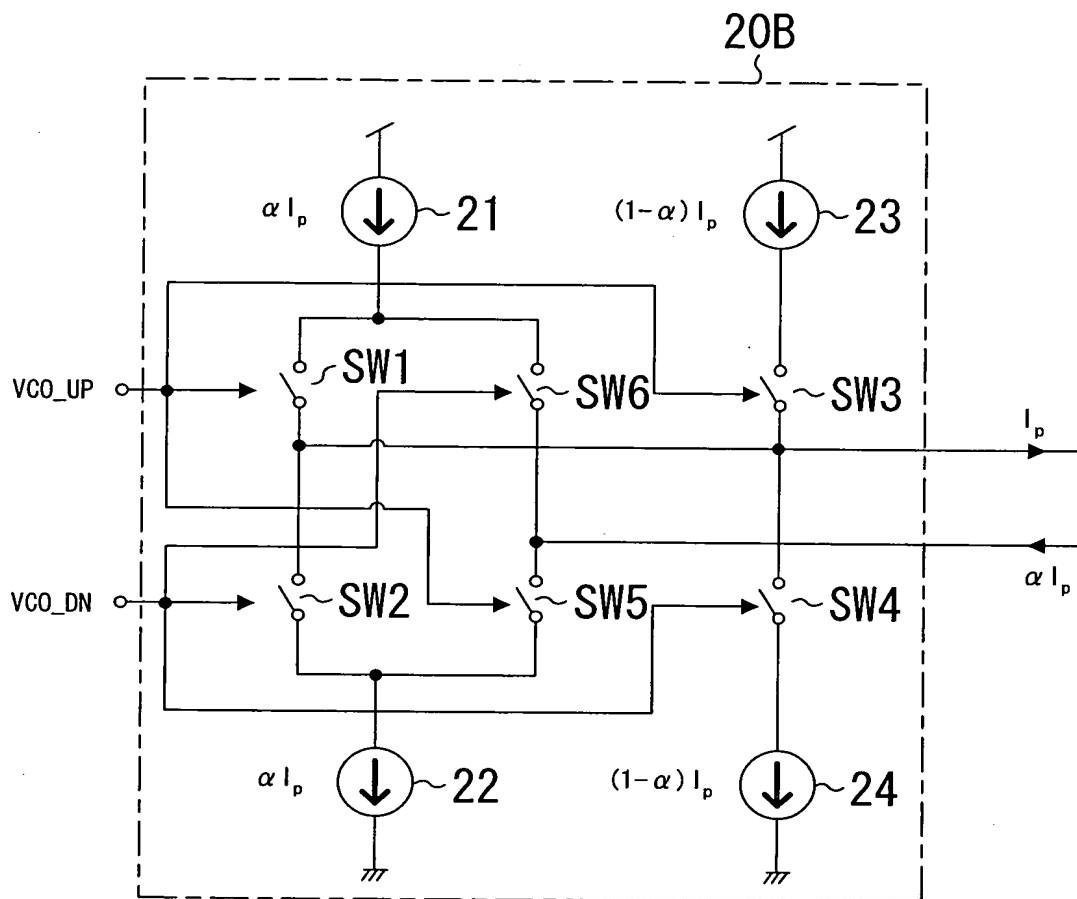


FIG. 6

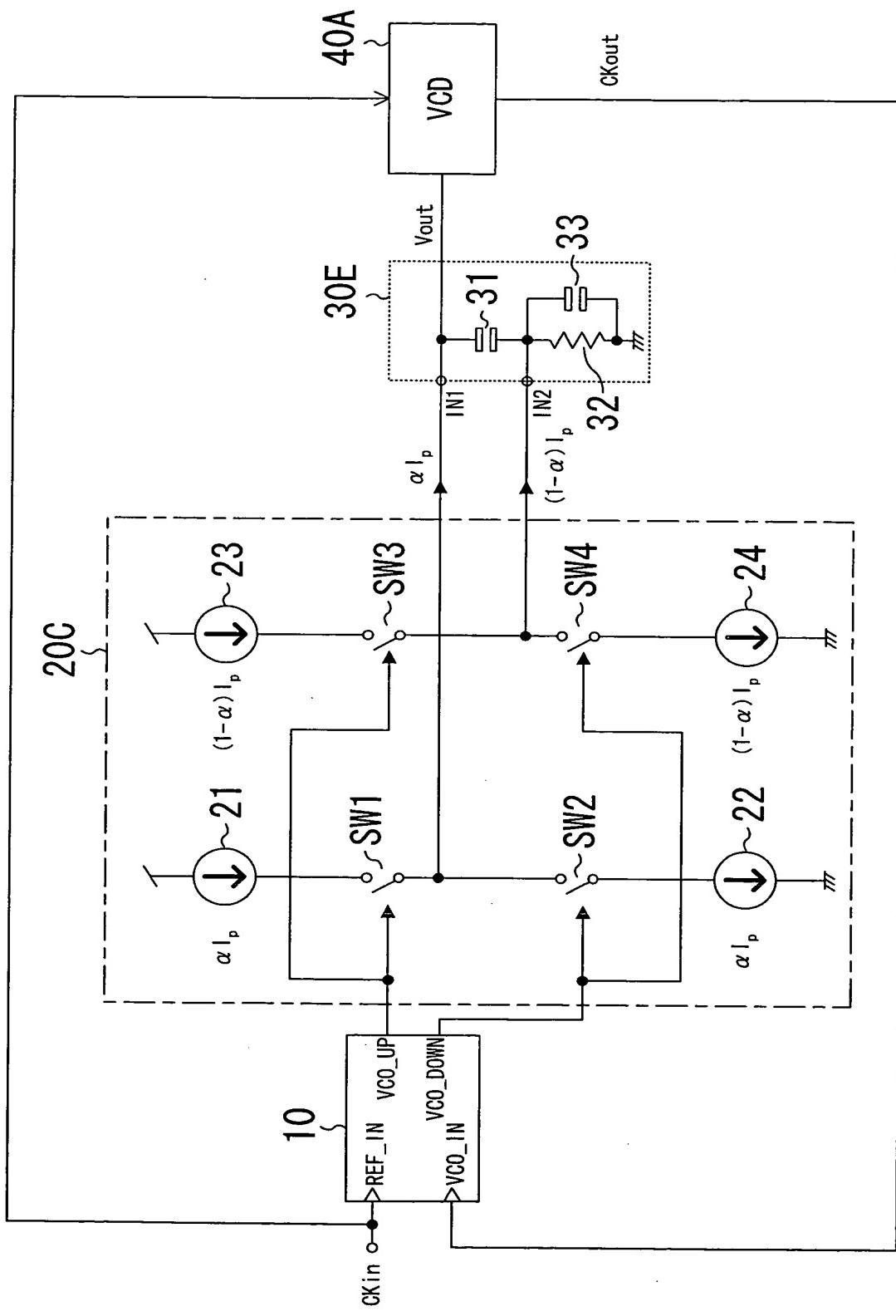
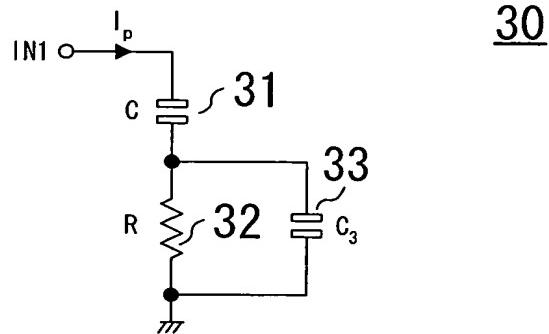


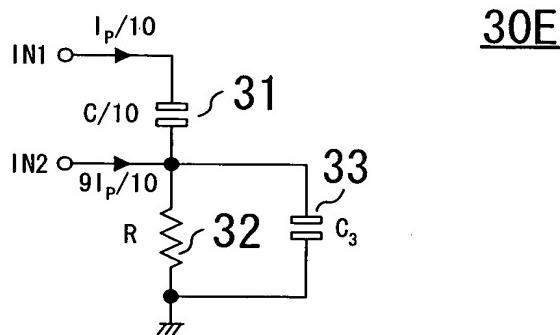
FIG. 7

(a)

30

Equivalent conversion

(b)

30E

Equivalent conversion

(c)

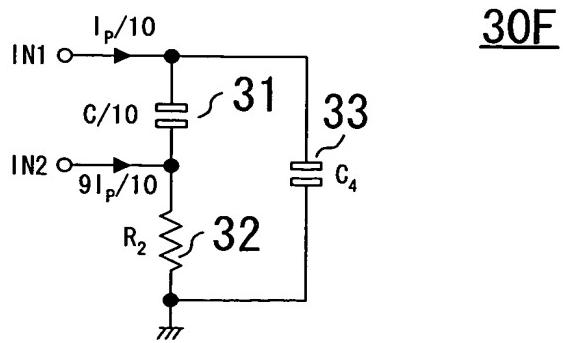
30F

FIG. 8

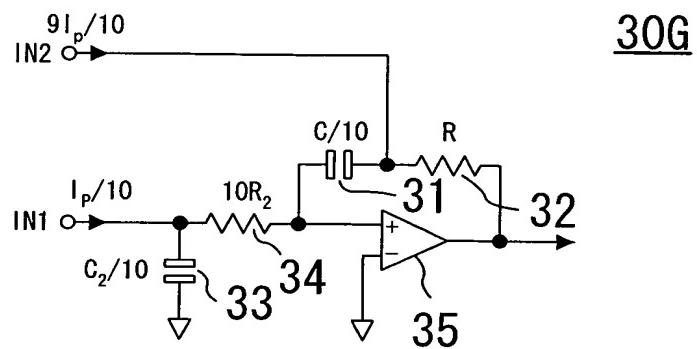
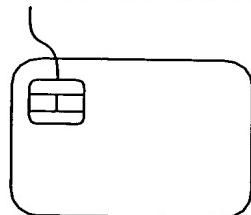


FIG. 9

LSI device incorporating PLL or
DLL of the present invention

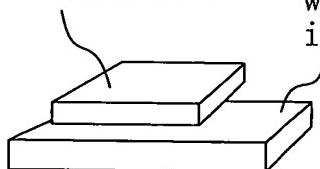


Application to IC card

FIG. 10

COC component
incorporating PLL or DLL
of the present invention

Base material to
which COC component
is attached



Application to COC component

FIG. 11

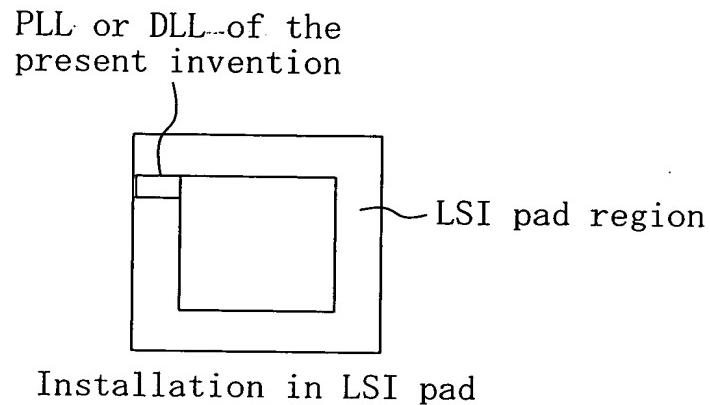


FIG. 12

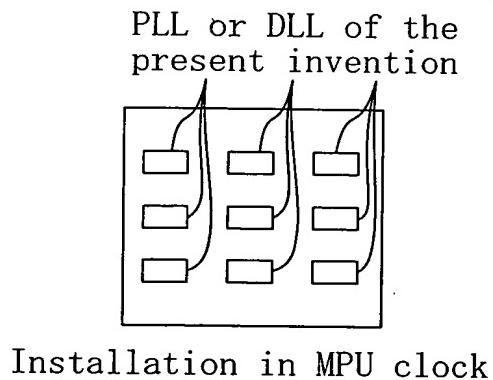


FIG. 13

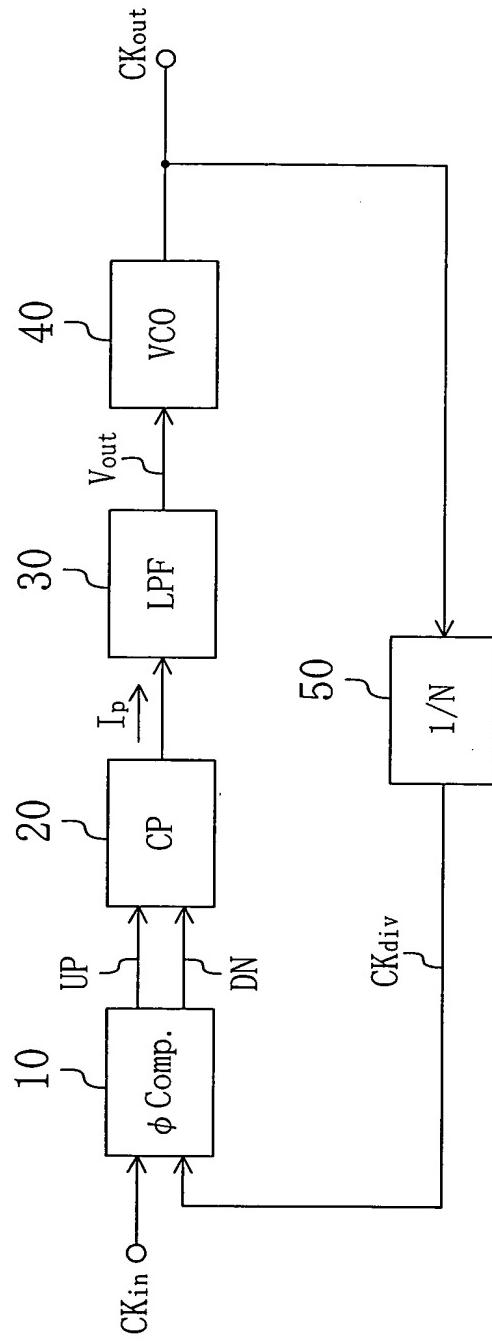


FIG. 14A

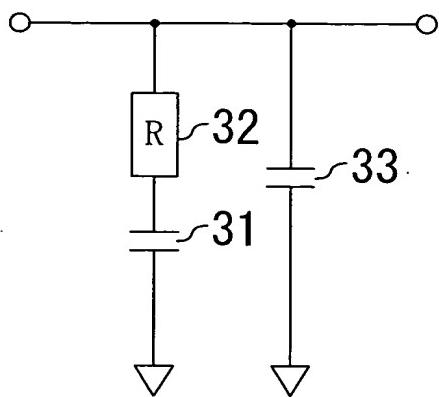
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FIG. 14B

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